

# SN54HC640, SN54HC643, SN54HC645 SN74HC640, SN74HC643, SN74HC645 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCLS003 D2684, DECEMBER 1982—REVISED JUNE 1989

- Choice of True or Inverting Logic
- High-Current 3-State Outputs Can Drive Up to 15 LSTTL Loads
- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs
- Dependable Texas Instruments Quality and Reliability

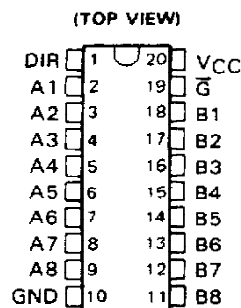
DEVICE	LOGIC
'HC640	Inverting
'HC643	True and Inverting
'HC645	True

### description

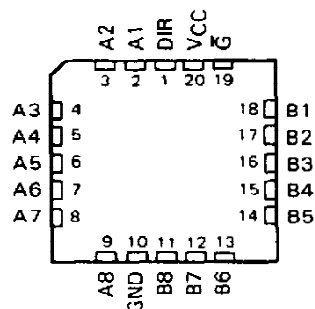
These octal bus transceivers are designed for asynchronous two-way communication between data buses. The devices transmit data from the A bus to the B bus or from the B bus to the A bus depending upon the level at the direction control (DIR) input. The enable input ( $\bar{G}$ ) can be used to disable the device so the buses are effectively isolated.

The SN54HC640, SN54HC643, and SN54HC645 are characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN74HC640, SN74HC643, and SN74HC645 are characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

SN54HC' . . . J PACKAGE  
SN74HC' . . . DW OR N PACKAGE



SN54HC' . . . FK PACKAGE  
(TOP VIEW)



FUNCTION TABLE

CONTROL INPUTS	OPERATION		
	'HC640	'HC643	'HC645
$\bar{G}$ DIR			
L L	$\bar{B}$ data to A bus	B data to A bus	B data to A bus
L H	$\bar{A}$ data to B bus	$\bar{A}$ data to B bus	A data to B bus
H X	Isolation	Isolation	Isolation

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

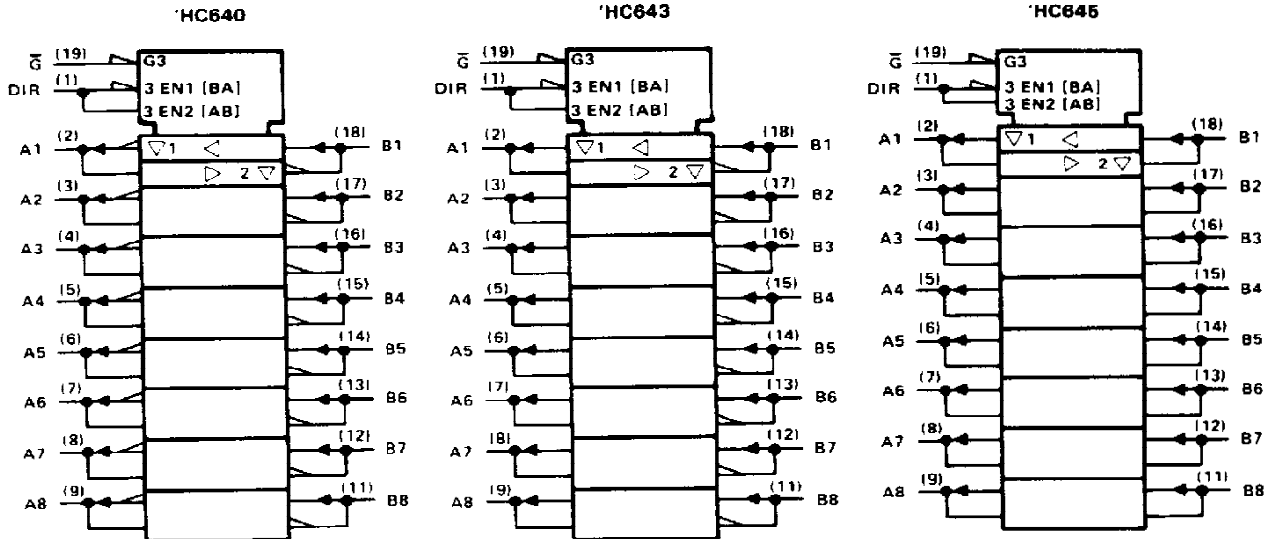
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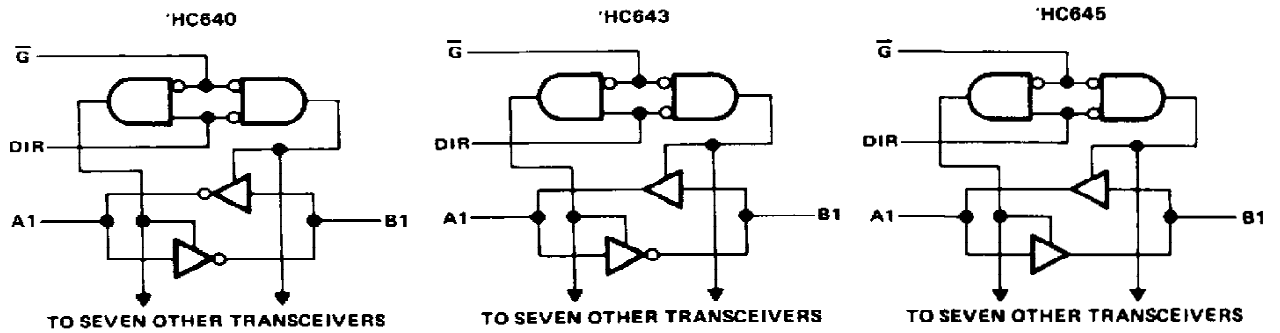
**SN54HC640, SN54HC643, SN54HC645  
 SN74HC640, SN74HC643, SN74HC645  
 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS**

**logic symbols†**



† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

**logic diagrams (positive logic)**



**SN54HC640, SN54HC643, SN54HC645  
SN74HC640, SN74HC643, SN74HC645  
OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS**

**absolute maximum ratings over operating free-air temperature range†**

Supply voltage, $V_{CC}$ .....	-0.5 V to 7 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) .....	$\pm 20$ mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) .....	$\pm 20$ mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) .....	$\pm 35$ mA
Continuous current through $V_{CC}$ or GND pins .....	$\pm 70$ mA
Lead temperature 1,6 mm (1/16 in) from case for 60 s: FK or J package .....	300 °C
Lead temperature 1,6 mm (1/16 in) from case for 10 s: DW or N package .....	260 °C
Storage temperature range .....	-65 °C to 150 °C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

**recommended operating conditions**

		SN54HC640 SN54HC643 SN54HC645			SN74HC640 SN74HC643 SN74HC645			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
$V_{CC}$	Supply voltage	2	5	6	2	5	6	V
$V_{IH}$	High-level input voltage	$V_{CC} = 2$ V		1.5	$V_{CC} = 2$ V		1.5	V
		$V_{CC} = 4.5$ V		3.15	$V_{CC} = 4.5$ V		3.15	
		$V_{CC} = 6$ V		4.2	$V_{CC} = 6$ V		4.2	
$V_{IL}$	Low-level input voltage	$V_{CC} = 2$ V		0	$V_{CC} = 2$ V		0	V
		$V_{CC} = 4.5$ V		0	$V_{CC} = 4.5$ V		0	
		$V_{CC} = 6$ V		0	$V_{CC} = 6$ V		0	
$V_I$	Input voltage	0 to $V_{CC}$			0 to $V_{CC}$			V
$V_O$	Output voltage	0 to $V_{CC}$			0 to $V_{CC}$			V
$t_t$	Input transition (rise and fall) times	$V_{CC} = 2$ V		0	$V_{CC} = 2$ V		0	ns
		$V_{CC} = 4.5$ V		0	$V_{CC} = 4.5$ V		0	
		$V_{CC} = 6$ V		0	$V_{CC} = 6$ V		0	
$T_A$	Operating free-air temperature	-55 to 125			-40 to 85			°C

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	$V_{CC}$	$T_A = 25^\circ\text{C}$			SN54HC640 SN54HC643 SN54HC645		SN74HC640 SN74HC643 SN74HC645		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$V_{OH}$	$V_I = V_{IH}$ or $V_{IL}$ , $I_{OH} = -20 \mu\text{A}$	2 V	1.9	1.998		1.9		1.9	V	
		4.5 V	4.4	4.499		4.4		4.4		
		6 V	5.9	5.999		5.9		5.9		
$V_{OL}$	$V_I = V_{IH}$ or $V_{IL}$ , $I_{OL} = 20 \mu\text{A}$	2 V		0.002	0.1	0.1		0.1	V	
		4.5 V		0.001	0.1	0.1		0.1		
		6 V		0.001	0.1	0.1		0.1		
$V_{OL}$	$V_I = V_{IH}$ or $V_{IL}$ , $I_{OL} = 6 \text{ mA}$	4.5 V		0.17	0.26	0.4		0.33	V	
		6 V		0.15	0.26	0.4		0.33		
		6 V		0.15	0.26	0.4		0.33		
$I_I$	DIR or $\bar{G}$	$V_I = V_{CC}$ or 0	6 V	$\pm 0.1$	$\pm 100$		$\pm 1000$	$\pm 1000$	nA	
$I_{OZ}$	A or B	$V_O = V_{CC}$ or 0	6 V	$\pm 0.01$	$\pm 0.5$		$\pm 10$	$\pm 5$	$\mu\text{A}$	
$I_{CC}$		$V_I = V_{CC}$ or 0, $I_O = 0$	6 V		8		160	80	$\mu\text{A}$	
$C_i$	DIR or $\bar{G}$		2 to 6 V	3	10		10	10	pF	



**SN54HC640, SN74HC640**  
**OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS**

switching characteristics over recommended operating free-air temperature range (unless otherwise noted),  $C_L = 50$  pF (see Note 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub>	T <sub>A</sub> = 25°C			SN54HC640		SN74HC640		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	A or B	B or A	2 V		29	105		160		130	ns
			4.5 V		10	21		32		26	
			6 V		8	18		27		22	
t <sub>en</sub>	$\bar{C}$	A or B	2 V		109	230		340		290	ns
			4.5 V		27	46		68		58	
			6 V		20	39		58		49	
t <sub>dis</sub>	$\bar{C}$	A or B	2 V		40	150		225		190	ns
			4.5 V		18	30		45		38	
			6 V		16	26		38		32	
t <sub>t</sub>		A or B	2 V		20	60		90		75	ns
			4.5 V		8	12		18		15	
			6 V		6	10		15		13	

C <sub>pd</sub>	Power dissipation capacitance per transceiver	No load, T <sub>A</sub> = 25°C	40 pF typ
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switching characteristics over recommended operating free-air temperature range (unless otherwise noted),  $C_L = 150$  pF (see Note 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub>	T <sub>A</sub> = 25°C			SN54HC640		SN74HC640		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	A or B	B or A	2 V		44	190		290		235	ns
			4.5 V		14	38		58		47	
			6 V		11	33		49		41	
t <sub>en</sub>	$\bar{C}$	A or B	2 V		124	315		470		395	ns
			4.5 V		31	63		94		79	
			6 V		23	54		80		68	
t <sub>t</sub>		A or B	2 V		45	210		315		265	ns
			4.5 V		17	42		63		53	
			6 V		13	36		53		46	

NOTE 1: Load circuit and voltage waveforms are shown in Section 1

**SN54HC643, SN74HC643**  
**OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS**

switching characteristics over recommended operating free-air temperature range (unless otherwise noted),  $C_L = 50$  pF (see Note 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub>	T <sub>A</sub> = 25°C			SN54HC643		SN74HC643		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	A or B	B or A	2 V		29	110		165		140	ns
			4.5 V		10	22		33		28	
			6 V		8	19		28		24	
t <sub>en</sub>	$\bar{C}$	A or B	2 V		109	230		340		290	ns
			4.5 V		27	46		68		58	
			6 V		20	39		58		49	
t <sub>dis</sub>	$\bar{C}$	A or B	2 V		40	150		225		190	ns
			4.5 V		18	30		45		38	
			6 V		16	26		38		32	
t <sub>t</sub>		A or B	2 V		20	60		90		75	ns
			4.5 V		8	12		18		15	
			6 V		6	10		15		13	

C <sub>pd</sub>	Power dissipation capacitance per transceiver	No load, T <sub>A</sub> = 25°C	40 pF typ
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switching characteristics over recommended operating free-air temperature range (unless otherwise noted),  $C_L = 150$  pF (see Note 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub>	T <sub>A</sub> = 25°C			SN54HC643		SN74HC643		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	A or B	B or A	2 V		44	195		295		245	ns
			4.5 V		14	39		59		49	
			6 V		11	34		50		43	
t <sub>en</sub>	$\bar{C}$	A or B	2 V		124	315		470		395	ns
			4.5 V		31	63		94		79	
			6 V		23	54		80		68	
t <sub>t</sub>		A or B	2 V		45	210		315		265	ns
			4.5 V		17	42		63		53	
			6 V		13	36		53		45	

NOTE 1: Load circuit and voltage waveforms are shown in Section 1.

**SN54HC645, SN74HC645**  
**OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS**

switching characteristics over recommended operating free-air temperature range (unless otherwise noted),  $C_L = 50$  pF (see Note 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub>	T <sub>A</sub> = 25°C			SN54HC645		SN74HC645		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	A or B	B or A	2 V		40	105	160		130		ns
			4.5 V		15	21	32		26		
			6 V		12	18	27		22		
t <sub>en</sub>	0	A or B	2 V		125	230	340		290		ns
			4.5 V		23	46	68		58		
			6 V		20	39	58		49		
t <sub>dis</sub>	0	A or B	2 V		74	200	300		250		ns
			4.5 V		25	40	60		50		
			6 V		21	34	51		43		
t <sub>t</sub>		A or B	2 V		20	60	90		75		ns
			4.5 V		8	12	18		15		
			6 V		6	10	15		13		

C <sub>pd</sub>	Power dissipation capacitance per transceiver	No load, T <sub>A</sub> = 25°C	40 pF typ
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switching characteristics over recommended operating free-air temperature range (unless otherwise noted),  $C_L = 150$  pF (see Note 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub>	T <sub>A</sub> = 25°C			SN54HC645		SN74HC645		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	A or B	B or A	2 V		54	135	200		170		ns
			4.5 V		18	27	40		34		
			6 V		15	23	34		29		
t <sub>en</sub>	0	A or B	2 V		150	270	405		335		ns
			4.5 V		31	54	81		67		
			6 V		25	46	69		56		
t <sub>t</sub>		A or B	2 V		45	210	315		265		ns
			4.5 V		17	42	63		53		
			6 V		13	36	53		45		

NOTE 1: Load circuit and voltage waveforms are shown in Section 1.

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**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
5962-87809012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
5962-8780901RA	ACTIVE	CDIP	J	20	1	TBD	A42 SNPB	N / A for Pkg Type
SN54HC640J	ACTIVE	CDIP	J	20	1	TBD	A42 SNPB	N / A for Pkg Type
SN54HC645J	ACTIVE	CDIP	J	20	1	TBD	A42 SNPB	N / A for Pkg Type
SN74HC640DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC640DWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC640DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC640DWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC640N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74HC640NE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74HC640NSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC640NSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC640PW	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC640PWE4	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC640PWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC640PWRE4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC640PWT	ACTIVE	TSSOP	PW	20	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC640PWTE4	ACTIVE	TSSOP	PW	20	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC645DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC645DWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC645DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC645DWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC645N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74HC645NE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74HC645NSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC645NSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54HC640FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SNJ54HC640J	ACTIVE	CDIP	J	20	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54HC645FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54HC645J	ACTIVE	CDIP	J	20	1	TBD	A42 SNPB	N / A for Pkg Type

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package is hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



4040140/D 10/96

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a metal lid.
  - D. The terminals are gold plated.
  - E. Falls within JEDEC MS-004

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MS-013 variation AC.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

PW (R-PDSO-G\*\*)

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14 PINS SHOWN



4040064/F 01/97

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 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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